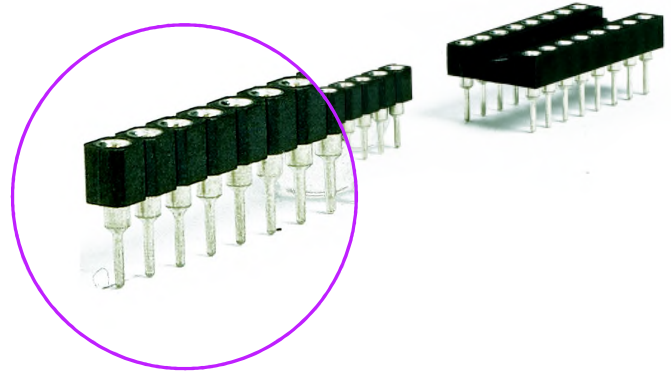


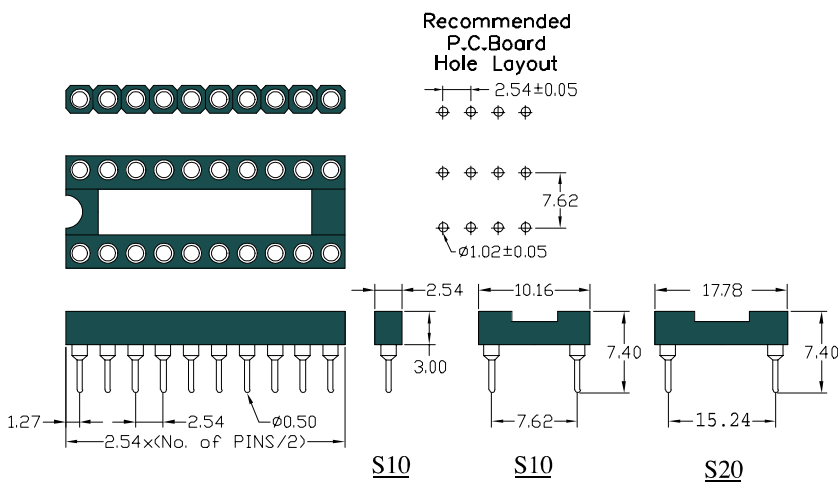
Other connectors Series

2.54mm , Round Pin IC Socket



SPECIFICATIONS

- * MATERIAL & FINISH
 - CONTACT: BE CU
 - PLATING: 10 MICRO INCH GOLD
- * SLEEVE: BRASS
 - PLATING: G= 10 MICRO INCH GOLD
 - T= 200 MICRO INCH TIN
- * INSULATOR:
 - GLASS FILLED POLYESTER, UL 94V-0
- * INSULATOR: AVERAGE 500 GR
- * EXTRACTION: TEST: AVERAGE 159 GR
- * RESIST TO SOLDERING HEAT:
 - MAX. 260°C, 5 SEC.
- * CONTACT RESIST: < = 100M OHMS
- * INSULATOR RESIST: > =5000M OHMS
- * DIELECTRIC WITHSTANDING: 600 VRMS
- * TEMPERATURE: -55°C TO +125°C



B 3 4 0 x - x x S x 0 - 0 1 T

1- Single row
2- Dual row

Number of contacts

S 1 0- Round pin
Single row
S 1 0- Width "7.62mm"
S 2 0- Width "15.24mm"

Plating thickness
01 Normal

Plating material
T Tin plated